Automotive Electronics **Product Information**

Oxygen sensor control and evaluation IC - CJ125





Integrated circuit for continuous lambda regulation with Ri measurement

The integrated circuit CJ125 is a control and amplifier circuit for a wide range λ sensor LSU4.x for the continuous regulation of λ in combination with the sensor in the range of $\lambda = 0.65 \dots \infty$ (air).

Customer benefits:

- Simple application
- Long- term availability of manufacturing processes and products
- QS9000 and ISO/TS16949 certified

Features

- Pump current control
- Pump current sense amplifier
- Lambda output amplifier
- Virtual ground voltage source for sensor and pump current control
- Nernst cell reference voltage source
- Circuit for Ri or Rical measurement
- Diagnostic of sensor lines
- Diagnostic of external heater
- Serial-Peripheral-Interface
- Programmable reference pumping currents
- Suppression of Ri-measurement

Block Diagram



Application circuit (proposal only!)



The application circuit consists of the following parts:

- Capacitor between [VCC] and [GND] to stabilize the supply voltage VCC
- Capacitor between [UB] and [GND] to stabilize the supply voltage VUB
- Capacitor between [CF] and [GND] to filter the lambda signal
- Capacitor between [UA] and [GND] to stabilize lambda signal output
- Capacitor between [UN] and [GND] to stabilize nernst signal
- Capacitor between [/RST] and [GND] to stabilize reset signal
- Shunt between [IA] and [IP] for pump current sensing
- Resistor between [IA] and [UP] to compensate parasitic effects of the lambda sensor

- Resistor between [US] and [UP] to feed the nernst cell reference voltage into the pump current control circuit
- Resistor between [UP] and [UN] for leakage detection
- Resistor between [RF] and [CF] to filter the lambda signal
- Capacitor between [UR] and [GND] to stabilize the output signal for ADC
- Capacitor between [UN] and [GND] for filtering
- Resistor between [RM] and capacitor at [CM] for adjustment of Ri measurement current
- Capacitor between [CM] and resistance at [RM] for DC filtering
- Resistor between [RS] and [VM] for adjustment
- Resistor between [DIAHD] and Drain of the external heater
- Resistor and capacitor before [UN] for filtering

Pin configuration



Pin description

Pin	Description
UB	Power supply input (14V)
VCC, VCCS ^{a)}	Power supply input (5V)
GND, GNDS ^{b)}	Ground
VM	Virtual ground of pump current control
	and of the LSU (0.5VCC)
US	Nernst cell reference voltage (450mV)
IP	Inverting input of pump current amplifier
	(shunt voltage)
IA	Non inverting input of pump current
	amplifier and output of the pump current
	control
RF	Output of pump current amplifier
	(-> external filter)
CF	Input of lambda output amplifier (after
	external filter)
UA	Output of lambda output amplifier
UP	Non inverting input of pump current
	control
UN	Inverting input of pump current control
	respective in-/output for Ri-measurement
	(LSU)

Pin	Description
RM	Output Ri-measurement current (DC)
СМ	Input Ri-measurement current (AC, DC free)
RS	In-/output Ri-calibration measurement
UR	Output Ri-signal (analogous)
DIAHG	Diagnosis input (gate of external
	transistor)
DIAHD	Diagnosis input (drain of external transistor)
SCK	Input SPI-clock (from µC)
SI	Input serial data (SPI, from μC)
SO	Output serial data (SPI, to µC)
/SS	Slave select (SPI, from µC)
/RST	Input Reset
OSZ	R _{extern} = 10kΩ

- a.) For hybrid version it is recommended to connect VVCS with the reference VCC for the ADC
- ^{b.)} For hybrid version it is recommended to connect GNDS with the reference ground for the ADC

Maximum Ratings

Parameter	Condition	Symbol	Min.	Max.	Unit
Supply voltage UB		Vub	-0.3	35	V
Supply voltage VCC		Vvcc	-0.3	5.5	V
	junction	TJ	-40	150	°C
	storage	Тѕт	-40	150	°C
Temperature	for max 50h		-40	125	°C
	ambient			125	°C
	for max 50h			140	°C
Maximum allowed voltages valid for pins: RM, UP, US,RF, CF, UA, UR, DIAHG, DIAHD; SCK, SI, SO, /SS, /RST, OSZ		Vx	-0.3	Vvcc + 0.3	V
Allowed current	ext. resistor 6.8 k Ω	Idiahd	-1	10	mA
Maximum allowed voltages, no destruction when ISO-pulses 3a,b are applied. Valid for board pins: RS, UN, VM, IA, IP, CM		Vx	-0.3	28	V
Offset between GND and GNDS		ΔV gnd	-0.25	0.25	V
Offset between VCC and VCCS		ΔVvcc	-0.25	0.25	V
ESD	Human Body Model R=1.5kΩ, C=100pF		-2	2	kV

Electrical Characteristics

Parameter	Condition	Symbol	Min.	Max.	Unit
Power Supply					
Power supply	Vgnd = Vgnds	Vub	9	18	V
Operating range	Vvcc = VVccs	Vvcc	4.75	5.25	V
Current consumption		lvcc		76	mA
Current consumption		lvccs		4	mA
Pump current control					
Offset voltage		Voff	-10	10	mV
Input current	-40°C ≤ Tj < 150°C	lup, un	-1	1	μA
Input offset current	-40°C ≤ Tj < 150°C	loff	-1	1	μA
Output current source condition	VUN < VUP; PA = 1; 0.5V < VIA < VCC-0.5V	-IA	10	30	mA
Output current sink condition	VUN > VUP; PA = 1; 0.6V < VIA < VCC-0.5V	la	10	30	mA
No output current	PA = 0	la	-10	10	μA
Pump current sense amplifier (LA = 0: meas	urement mode; LA = 1: adjustment	t mode)			
Input current	-40°C ≤ Tj < 150°C	lip	-1	1	μA
Amplification	SPI-bit VL = 1	Ao	16.62	17.24	
Amplification	SPI-bit VL = 0	Ao	7,82	8.15	
Common mode rejection ratio	CMRR ⁻¹ = ΔV _{UA} / ΔV _{IP} V _{IP} =V _{IA} =14V 0.5V < V _{UA} < V _{CC} -0.5V I _{UA} < 10μA	CMRR ^{.1}		12	mV/V
Output voltage swing	IUA < 10µA; LA = 0	Vua	0.20	Vvcc -0.18	V
Output voltage adjustment	IRF =0µA; LA = 1	VFR/ VVCC	0.285	0.315	
Output error offset adjust		Δνυα	-3	3	mV

Electrical characteristics

Parameter	Condition	Symbol	Min.	Max.	Unit	
Diagnosis of sensor lines						
Short circuit to ground		VVM / VVCC	0.35	0.45		
Short circuit to Vbat		VVM / VVCC	0.55	0.65		
Short circuit to ground		VUN / VVCC	0.30	0.40		
Short circuit to Vbat		VUN / VVCC	0.72	0.88		
Short circuit to ground		VIA,IP	0.3	1.5	V	
Short circuit to Vbat		VIA	Vvcc	Vvcc + 2	V	
Diagnosis of external heater						
Low level		Vdiahg	-0.3	0.3 Vvcc	V	
High level		Vdiahg	0.7 Vvcc	Vvcc + 0.3	V	
Input current (no pull up!)		- Idiahg	-1	1	μA	
Short circuit to ground	DIAHG = low	Idiahd	-1000	-350	μA	
Short circuit to Vbat	DIAHG = high	Idiahd	-100	10 000	μA	
Open load	DIAHG = low	Idiahd	-100	100	μA	
No failure	DIAHG = high	Idiahd	-1000	-350	μA	
No failure	DIAHG = low	Idiahd	350	10 000	μA	
Filter time	T = 1 / f	tdiag / T	30 / 32	32 / 32		
SPI						
Data rate				2	Mbaud	
Bit-frame				16	bit	
Number of read / write commands				6		
Number of register				4		

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